OSRAM LW TWTG.BB **Datasheet**

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TOPLED® Black Surface

LW TWTG.BB

TOPLED, SMT LED with integrated reflector. With our great experience in SMT LED we are able to offer a high quality product for all kind of applications.





Applications

- Projection & Display

Features

- Package: white PLCC-2 package, black surface, colored diffused silicone resin

- Chip technology: UX:3

- Typ. Radiation: 120°

- Color: Cx = 0.32, Cy = 0.33 acc. to CIE 1931 (white)

- Corrosion Robustness Class: 1B

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



Ordering Information		
Туре	Luminous Intensity ¹⁾ I _F = 20 mA I _v	Ordering Code
LW TWTG.BB-BXBY-2B12B3-Z486	1800 2400 mcd	Q65112A5796
LW TWTG.BB-BXCX-2B12C3-Z486	1800 3300 mcd	Q65112A5797
LW TWTG.BB-BYBZ-2B12C3-Z486	2100 2800 mcd	Q65112A5795
LW TWTG.BB-BYBZ-2C12C3-Z486	2100 2800 mcd	Q65112A5793



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
	ű.	max.	100 °C
Storage Temperature	T _{stg}	min.	-40 °C
	0.9	max.	100 °C
Junction Temperature	T _j	max.	110 °C
Forward current	I _F	max.	30 mA
$T_S = 25 ^{\circ}C$	•		
Surge current	I _{FS}	max.	100 mA
$t \le 10 \ \mu s; D = 0.005 ; T_s = 25 \ ^{\circ}C$	10		
ESD withstand voltage	V_{ESD}		8 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	LGD		
Reverse current 2)	I _R	max.	50 mA



Characteristics

 I_F = 20 mA; T_S = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate 3)	Сх	typ.	0.32
	Су	typ.	0.33
Viewing angle at 50% I _v	2φ	typ.	110 °
Forward Voltage 4)	V _F	min.	2.70 V
$I_F = 20 \text{ mA}$	•	typ.	3.05 V
		max.	3.40 V
Reverse voltage (ESD device)	V _{R ESD}	min.	5 V
Reverse voltage ²⁾ I _R = 5 mA	V_R	max.	7 V
Real thermal resistance junction/ambient 5)6)	R _{thJA real}	max.	230 K / W
Real thermal resistance junction/solderpoint 5)	R _{thJS real}	max.	78 K / W



Brightness Groups

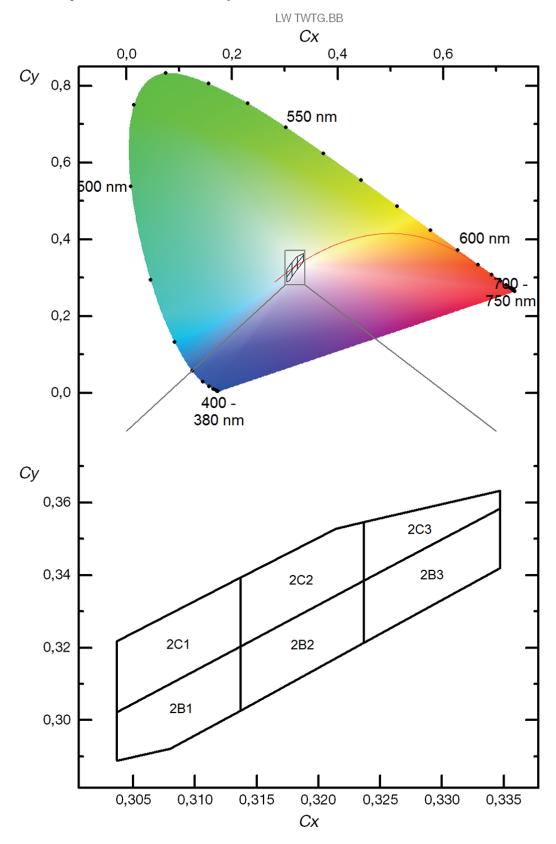
Group	Luminous Intensity 1) I _F = 20 mA	Luminous Intensity ¹⁾ I _F = 20 mA	Luminous Flux ⁷⁾ I _F = 20 mA		
	min. L	max. I	typ. Φ _v		
		v			
BX	1800 mcd	2100 mcd	5850 mlm		
BY	2100 mcd	2400 mcd	6750 mlm		
BZ	2400 mcd	2800 mcd	7800 mlm		
CX	2800 mcd	3300 mcd	9150 mlm		

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 20 mA min. V _F	Forward Voltage ⁴⁾ I _F = 20 mA max. V _F	
Z4	2.70 V	2.90 V	
44	2.90 V	3.10 V	
86	3.10 V	3.40 V	



Chromaticity Coordinate Groups





Chroma	ticity Cod	ordinate C	Groups 3)					
Group	Сх	Су	Group	Cx	Су	Group	Cx	Су
2B1	0.3080	0.2921	2B3	0.3237	0.3385	2C2	0.3137	0.3203
	0.3037	0.2888		0.3347	0.3584		0.3137	0.3393
	0.3037	0.3022		0.3347	0.3419		0.3214	0.3528
	0.3137	0.3203		0.3237	0.3214		0.3237	0.3546
	0.3137	0.3027	2C1	0.3037	0.3218		0.3237	0.3385
2B2	0.3137	0.3203		0.3137	0.3393	2C3	0.3237	0.3546
	0.3237	0.3385		0.3137	0.3203		0.3347	0.3633
	0.3237	0.3214		0.3037	0.3022		0.3347	0.3584
	0.3137	0.3027					0.3237	0.3385

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Group Name on Label

Example: BX-2B1-44

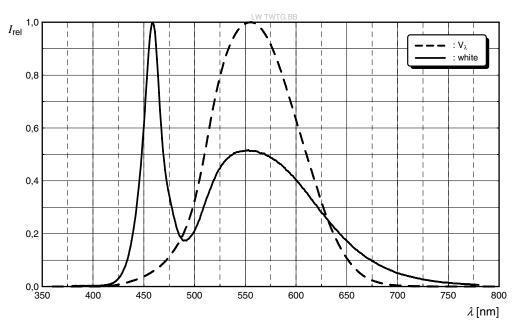
Brightness Color Chromaticity Forward Voltage

ВХ 2B1 44



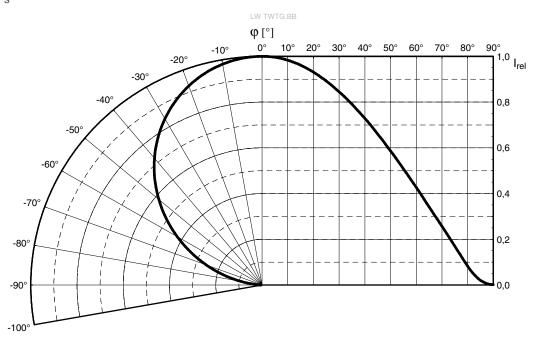
Relative Spectral Emission 7)

 I_{rel} = f (λ); I_{F} = 20 mA; T_{S} = 25 °C



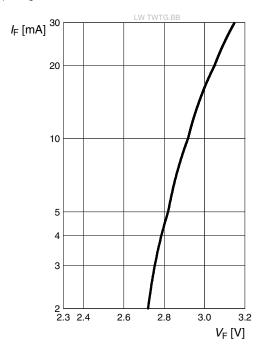
Radiation Characteristics 7)

 $I_{rel} = f(\phi); T_S = 25 °C$



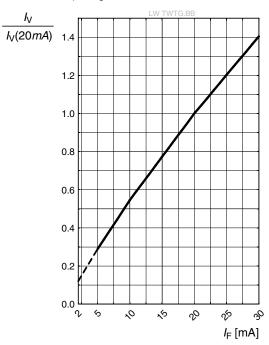
Forward current 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



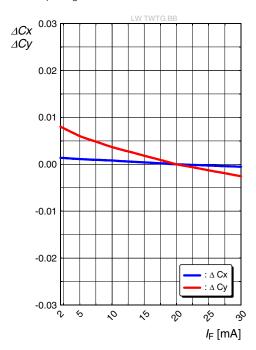
Relative Luminous Intensity 7), 8)

$$I_v/I_v(20 \text{ mA}) = f(I_F); T_S = 25 \text{ °C}$$



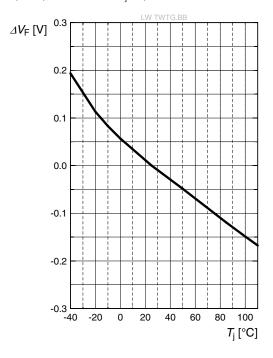
Chromaticity Coordinate Shift 7)

 ΔCx , $\Delta Cy = f(I_F)$; $T_S = 25 \, ^{\circ}C$



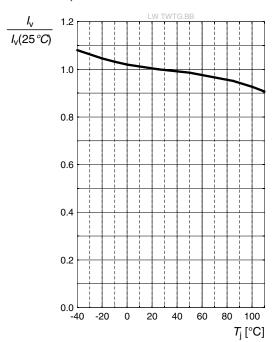
Forward Voltage 7)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_j); I_F = 20 \ mA$$



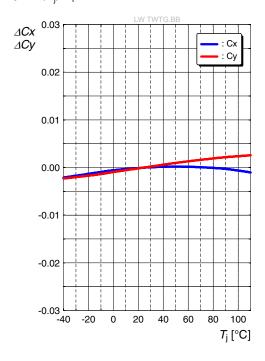
Relative Luminous Intensity 7)

$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 20 \text{ mA}$$



Chromaticity Coordinate Shift 7)

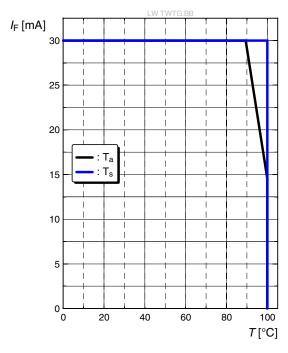
 ΔCx , $\Delta Cy = f(T_j)$; $I_F = 20 \text{ mA}$





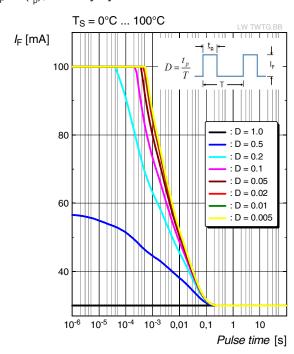
Max. Permissible Forward Current 5)

 $I_F = f(T)$



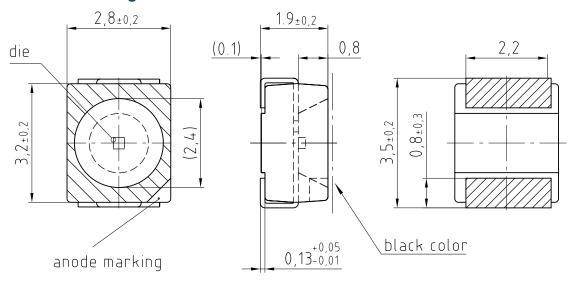
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle





Dimensional Drawing 9)



general tolerance \pm 0.1 lead finish Sn

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Further Information:

Approximate Weight: 33.0 mg

Package marking: Anode

Corrosion test: Class: 1B

Test condition: 25°C / 75 % RH / 200ppb SO₂, 200ppb NO₂, 10ppb H₂S,

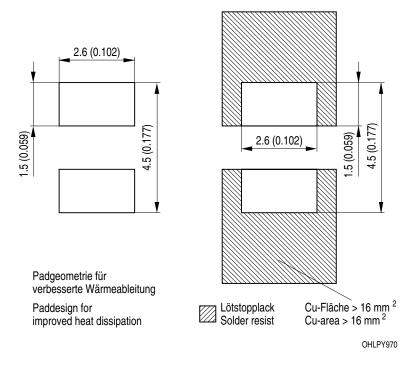
10ppb Cl₂ / 21 days (EN 60068-2-60 (Method 4))

The device is protected by ESD device which is connected in parallel to the **ESD** advice:

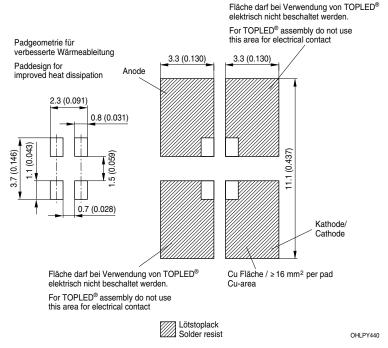
Chip.



Recommended Solder Pad 9)



Recommended Solder Pad 9)

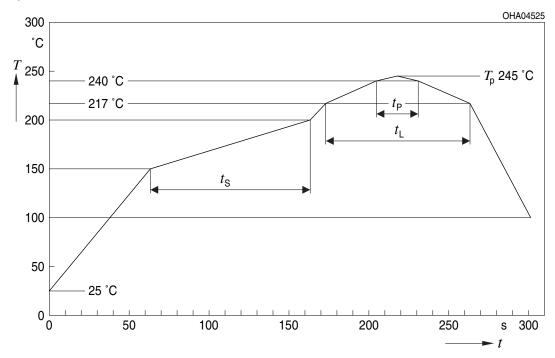


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



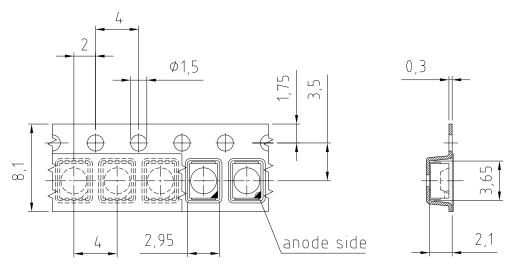
Profile Feature	Symbol	Pb	-Free (SnAgCu) Ass	sembly	Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t _s	60	100	120	S
Ramp-up rate to peak $^{*)}$ T _{Smax} to T _P			2	3	K/s
Liquidus temperature	T_{L}		217		°C
Time above liquidus temperature	t _L		80	100	S
Peak temperature	T_{P}		245	260	°C
Time within 5 °C of the specified peak temperature T _p - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

All temperatures refer to the center of the package, measured on the top of the component

^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



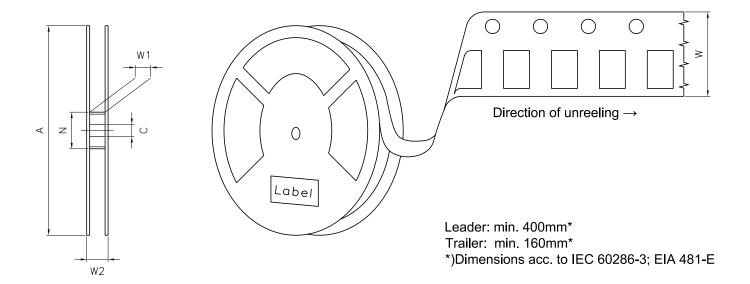
Taping 9)



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Tape and Reel 10)

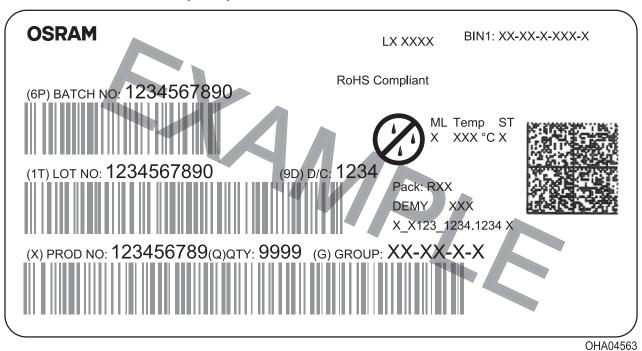


Reel Dimensions

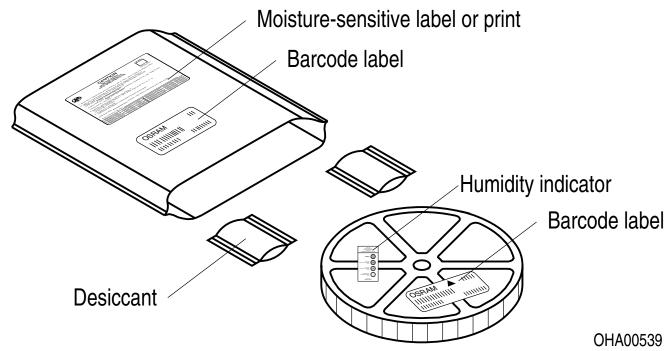
Α	W		N_{\min}	W_1		$W_{2 \text{ max}}$	Pieces per PU
180 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	2000
330 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	8000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



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Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- 2) Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) Thermal Resistance: Rth max is based on statistic values (6 σ) used for Derating.
- 6) Thermal Resistance: RthJA results from mounting on PC board FR 4 (pad size 16 mm² per pad)
- 7) Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differ-8) ences between single devices within one packing unit.
- 9) Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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Revision History			
Version	Date	Change	
1.3	2024-02-13	Tape and Reel Reel Dimensions New Layout	



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

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